

45V N-Channel Enhancement Mode MOSFET

Description

The PECN4575G uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge. It can be used in a wide variety of applications.

General Features

- ◆ $V_{DS} = 45V \quad I_D = 75A$
 $R_{DS(ON)}(\text{Typ.}) = 6.2m\Omega \quad @ V_{GS} = 10V$
 $R_{DS(ON)}(\text{Typ.}) = 7.2m\Omega \quad @ V_{GS} = 4.5V$
- ◆ High density cell design for ultra low $R_{DS(on)}$
- ◆ Fully characterized avalanche voltage and current
- ◆ Good stability and uniformity with high E_{AS}
- ◆ Excellent package for good heat dissipation
- ◆ Special process technology for high ESD capability

Application

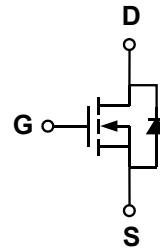
- ◆ Automotive applications
- ◆ Hard switched and high frequency circuits
- ◆ Uninterruptible power supply

Package

- ◆ TO-252-2L

100% UIS TESTED!
100% ΔV_{DS} TESTED!

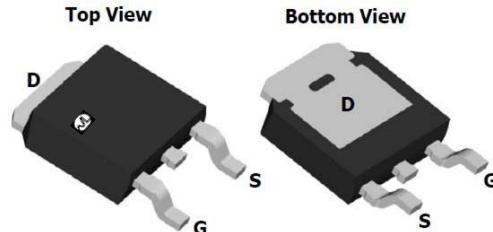
Schematic diagram



Marking and pin assignment

TO-252-2L

(Top View)



PECN4575G—Product

Name XXXX—Wafer Lot
No.



YYYY—Quality Code

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
PECN4575G	-55°C to +150°C	TO-252-2L	2500

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	V_{DS}	45	V
Gate-source voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	75	A
TC=100°C		50	
Pulsed Drain Current	I_{DP}	300	A
Avalanche energy (L=0.5mH) ^(note1)	E_{AS}	200	mJ
Maximum power dissipation	P_D	60	W
Operating junction Temperature range	T_j	-55—150	°C

Electrical Characteristics (TA=25°C unless otherwise noted)

Parameter	Symbol	Condition		Min	Typ	Max	Unit
Static Characteristics							
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0V, I _D =250μA		45	55	-	V
Zero gate voltage drain current	I _{DSS}	V _{DS} =45V, V _{GS} =0V	T _J =25°C	-	-	1	μA
			T _J =85°C	-	-	5	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V		-	-	±100	nA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA		1.00	1.50	2.00	V
Drain-source on-state resistance ¹	R _{DS(ON)}	V _{GS} =10V, I _D =75A		-	6.2	8	mΩ
		V _{GS} =4.5V, I _D =60A		-	7.2	9	
Forward Transconductance	I _{D(ON)}	V _{DS} =5V, I _D =20A		20	-	-	S
Diode Characteristics							
Diode Continuous Forward Current	I _s			-	-	12	A
Reverse Recovery Time	t _{rr}	I _F =40A, dI/dt=20A/us		-	29	-	ns
Reverse Recovery Charge	Q _{rr}			-	26	-	nC
Dynamic Characteristics²							
IPECNut capacitance	C _{ISS}	V _{GS} =0V ,V _{DS} =22.5V f=1.0MHz		-	2600	-	pF
Output capacitance	C _{OSS}			-	241	-	
Reverse transfer capacitance	C _{RSS}			-	195	-	
Turn-on delay time	t _{D(ON)}	V _{GS} =10V, V _{DD} =22.5V, R _L =1Ω, R _G =2Ω		-	6.5	-	ns
Turn-on Rise time	tr			-	17	-	
Turn-off delay time	t _{D(OFF)}			-	29.5	-	
Turn-off Fall time	tf			-	17	-	
Total gate charge	Q _g	V _{GS} =10V,I _D =2A V _{DS} =10V		-	60		nC
Gate-source charge	Q _{gs}				6.1		
Gate-drain charge	Q _{gd}			-	12	-	
Drain-Source Diode Characteristics							
Diode forward voltage	V _{SD}	I _{SD} =10A,V _{GS} =0V		-	0.8	1.2	V

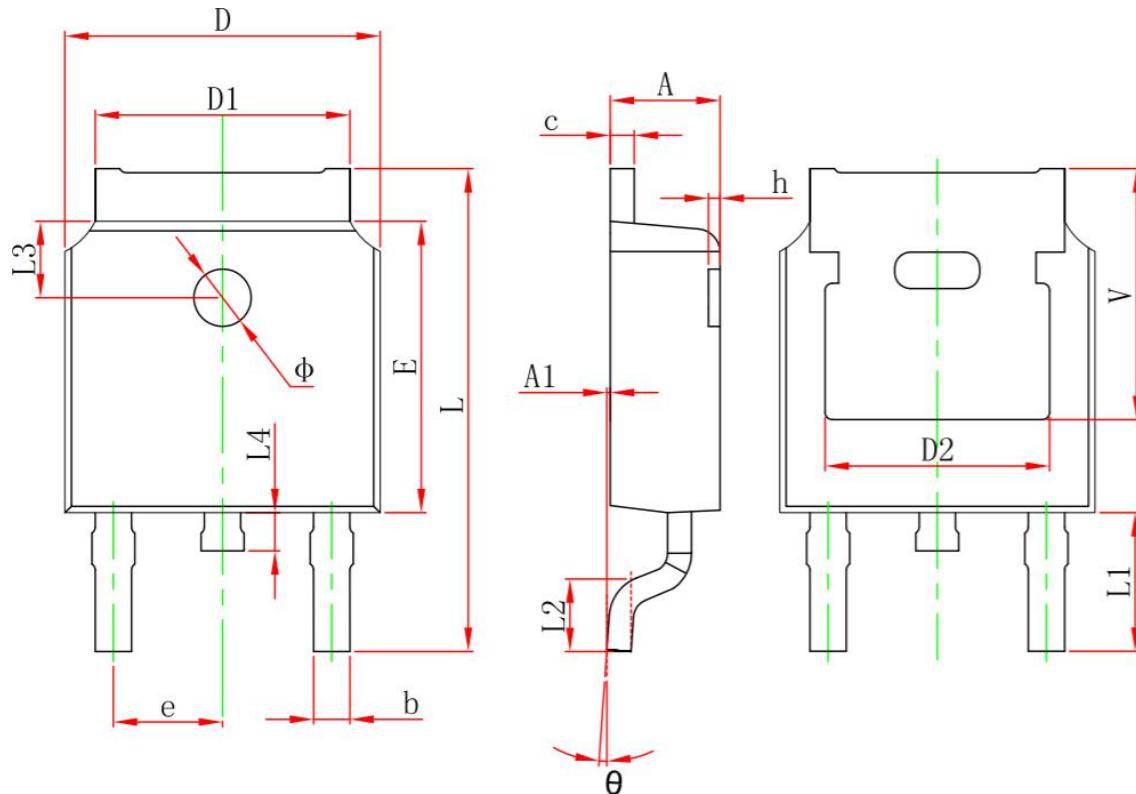
Note: 1: Eas test: V_{DD}=10V, R_G=25ohm, L=500uH 2:

Pulse test; pulse width ≤ 300ns, duty cycle ≤ 2%.

3: Guaranteed by design, not subject to production testing.

Package Information

- TO-252-2L



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.200	2.400	0.087	0.094
A1	0.000	0.127	0.000	0.005
b	0.660	0.860	0.026	0.034
c	0.460	0.580	0.018	0.023
D	6.500	6.700	0.256	0.264
D1	5.100	5.460	0.201	0.215
D2	4.830 REF.		0.190 REF.	
E	6.000	6.200	0.236	0.244
e	2.186	2.386	0.086	0.094
L	9.800	10.400	0.386	0.409
L1	2.900 REF.		0.114 REF.	
L2	1.400	1.700	0.055	0.067
L3	1.600 REF.		0.063 REF.	
L4	0.600	1.000	0.024	0.039
φ	1.100	1.300	0.043	0.051
θ	0°	8°	0°	8°
h	0.000	0.300	0.000	0.012
V	5.350 REF.		0.211 REF.	